19-5670; Rev 0; 12/10

EVALUATION KIT AVAILABLE

point and 3rd-order intercept point.

level package (WLP).

The MAX2674/MAX2676 are ultra-small, high-IP3, low-

noise amplifiers (LNAs) designed for GPS L1, Galileo,

and GLONASS applications. Designed in Maxim's

advanced SiGe process, the devices are also equipped

with an autosensing feature for applications that enable the use of external antennas. These high-performance

LNAs provide high gain and an ultra-low noise figure

while optimizing the input-referred 2dB compression

The ultra-small size is ideal for front-end modules and

receiver applications in cellular phones, smartphones,

PDAs, PNDs, or other custom GNSS applications. The MAX2674/MAX2676 operate from a 1.6V to 3.6V single

supply. The MAX2674 is optimized for high gain, while

the MAX2676 is optimized for high linearity. A shutdown

feature is present in both devices reducing the supply

current to less than 10µA. The antenna port automati-

cally senses when an external antenna is connected,

eliminating the need for additional control circuitry

while also providing improved short-circuit protection.

The MAX2674/MAX2676 are available in an ultra-small, RoHS-compliant 0.86mm x 1.26mm x 0.64mm wafer-



GPS/GNSS LNAs with Antenna Switch and Bias

General Description

Features

- Eliminate Discrete Antenna Sensing, Switching, and Bias Networks Autodetect Antenna Connection **Provide Antenna Bias Short-Circuit Protection**
 - Wide 1.6V to 3.6V Supply Voltage Range
 - Ultra-Small Footprint (0.86mm x 1.26mm) WLP Package
 - ♦ For Applications Without Antenna Port, Use Pin-Compatible 4-Bump MAX2686/MAX2687/MAX2688 LNA

Applications

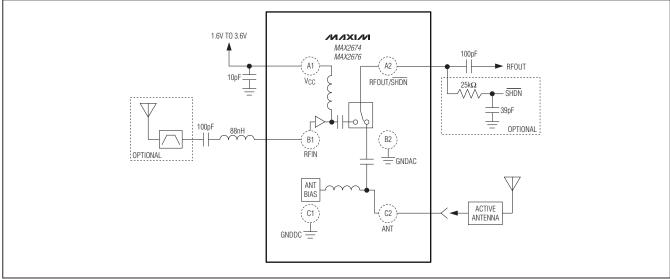
Front-End SAW Modules **Receiver Modules** Cellular and Smartphones Avionics and Military Telematics (Asset Tracking and Management) Personal Navigation Devices (PNDs) Recreational, Marine Navigation

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX2674EWT+T	-40°C to +85°C	6 WLP
MAX2676EWT+T	-40°C to +85°C	6 WLP

+Denotes a lead(Pb)-free/RoHS-compliant package. T = Tape and reel.

Typical Operating Circuit



M/X/M

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

MAX2674/MAX2676

ABSOLUTE MAXIMUM RATINGS

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +160°C
Soldering Temperature (reflow, Note 1)	+260°C

Note 1: Refer to Application Note 1891: Wafer-Level Packaging (WLP) and its Applications.



Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = 1.6V to 3.6V, no RF signal applied, $T_A = -40^{\circ}$ C to +85°C. Typical values are at V_{CC} = 3.3V, $T_A = +25^{\circ}$ C, unless otherwise noted.) (Note 2)

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Voltage		1.6	3.3	3.6	V
Supply Current			4.5	7	mA
Shutdown Current	$V_{\overline{SHDN}} = 0V$			10	μA
Shutdown Logic-Low				0.45	V
Shutdown Logic-High		1.2			V
ANT Sense Threshold	Causes autosense to switch to ANT	75	200	850	μA
ANT Current Limit	ANT connected to GND_	20	30	45	mA
ANT Port Supply Drop	Voltage drop from V _{CC} with 10mA load on ANT		75		mV

AC ELECTRICAL CHARACTERISTICS

(V_{CC} = 1.6V to 3.6V, f_{RFIN} = 1575.42MHz, T_A = -40°C to +85°C. Typical values are at V_{CC} = 3.3V, T_A = +25°C, unless otherwise noted.) (Note 2)

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS	
Minimum RF Input Frequency			1575.42		MHz	
Maximum RF Input Frequency			1610		MHz	
Davier O alia	MAX2674	13	18			
Power Gain	MAX2676	11	15		dB	
Noise Figure			0.75		dB	
	MAX2674, RF input = $f_{O} \pm 2.5$ MHz at -40dBm each		-2			
In-Band Input IP3	MAX2676, RF input = $f_0 \pm 2.5$ MHz at -40dBm each		+5		dBm	
ANT In-Band Input IP3	RF input = $f_0 \pm 2.5$ MHz at -25dBm each		+30		dBm	

AC ELECTRICAL CHARACTERISTICS (continued)

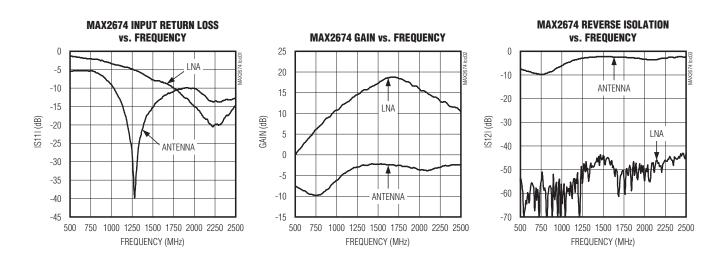
(VCC = 1.6V to 3.6V, f_{RFIN} = 1575.42MHz, T_A = -40°C to +85°C. Typical values are at VCC = 3.3V, T_A = +25°C, unless otherwise noted.) (Note 2)

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS	
Out of Dand Input ID2	MAX2674, RF input = 1713.42MHz, -17dBm and 1851.42MHz, -59dBm		3		dDaa	
Out-of-Band Input IP3	MAX2676, RF input = 1713.42MHz, -17dBm and 1851.42MHz, -59dBm		5		dBm	
	MAX2674, f _{RFIN} = 1580.42MHz		-7		dDm	
Input P2dB	MAX2676, f _{RFIN} = 1580.42MHz		-4		dBm	
Input Return Loss			15		dB	
Output Return Loss			15		dB	
Reverse Isolation			45		dB	
ANT Insertion Loss			1.5		dB	
RFIN to ANT Isolation			45		dB	

Note 2: Guaranteed by test at $T_A = +25^{\circ}$ C, guaranteed by design and characterization at $T_A = -40^{\circ}$ C and $T_A = +85^{\circ}$ C.

Typical Operating Characteristics

(MAX2674/MAX2676 EV Kit. Typical values are at V_{CC} = 3.3V, T_A = +25°C, unless otherwise specified.)



MAX2674 ACTIVE PATH IN-BAND IIP3

Typical Operating Characteristics (continued)

MAX2674 ANTENNA PATH IN-BAND IIP3

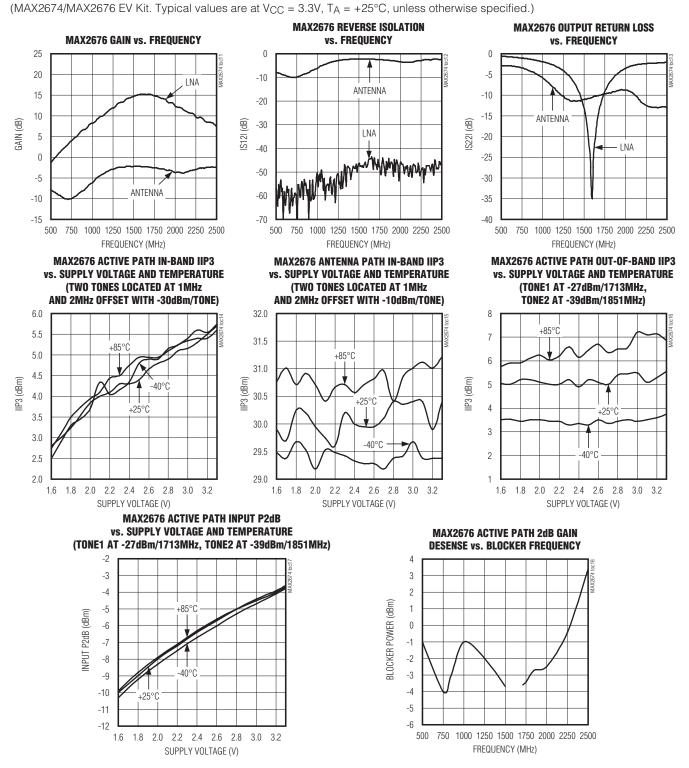
(MAX2674/MAX2676 EV Kit. Typical values are at V_{CC} = 3.3V, T_A = +25°C, unless otherwise specified.)

vs. SUPPLY VOLTAGE AND TEMPERATURE **vs. SUPPLY VOLTAGE AND TEMPERATURE MAX2674 OUTPUT RETURN LOSS** (TWO TONES LOCATED AT 1MHz AND (TWO TONES LOCATED AT 1MHz vs. FREQUENCY 2MHz OFFSET WITH -30dBm/TONE) AND 2MHz OFFSET WITH -10dBm/TONE) 0 0 32.0 40°C 31.5 -5 -1 -10 ANTENNA 31.0 +85 +25°C +25°C (dB) IIP3 (dBm) IP3 (dBm S22I (-2 -15 30.5 ¥ LNA -20 30.0 -3 -40°C -25 29.5 +85°C -30 -4 29.0 500 750 1000 1250 1500 1750 2000 2250 2500 1.6 1.8 2.0 2.2 2.4 2.6 2.8 3.0 3.2 1.6 1.8 2.0 2.2 2.4 2.6 2.8 3.0 3.2 FREQUENCY (MHz) SUPPLY VOLTAGE (V) SUPPLY VOLTAGE (V) MAX2674 ACTIVE PATH OUT-OF-BAND IIP3 MAX2674 ACTIVE PATH INPUT P2dB vs. SUPPLY VOLTAGE AND TEMPERATURE vs. SUPPLY VOLTAGE AND TEMPERATURE (TONE1 AT -27dBm/1713MHz, TONE2 AT -39dBm/1851MHz) (TONE1 AT -27dBm/1713MHz, TONE2 AT -39dBm/1851MHz) 5 -4 -5 40°C 4 -6 3 -7 NPUT P2dB (dBm) +85°C 2 -8 IIP3 (dBm) 1 _9 -10 +25°C 0 -11 +85°C -1 -12 -40°C -2 -13 -3 -14 $1.6 \quad 1.8 \quad 2.0 \quad 2.2 \quad 2.4 \quad 2.6 \quad 2.8 \quad 3.0 \quad 3.2$ 1.6 1.8 2.0 2.2 2.4 2.6 2.8 3.0 3.2 SUPPLY VOLTAGE (V) SUPPLY VOLTAGE (V) **MAX2674 ACTIVE PATH 2dB GAIN MAX2676 INPUT RETURN LOSS DESENSE vs. BLOCKER FREQUENCY** vs. FREQUENCY 0 0 ΙΝΔ -5 -1 -10 -2 BLOCKER POWER (dBm) -15 -3 IS111 (dB) -20 -4 -25 -5 -30 ANTENNA -6 -35 -7 -40 -8 -45 500 750 1000 1250 1500 1750 2000 2250 2500 750 1000 1250 1500 1750 2000 2250 2500 500 FREQUENCY (MHz) FREQUENCY (MHz)

MAX2674/MAX2676

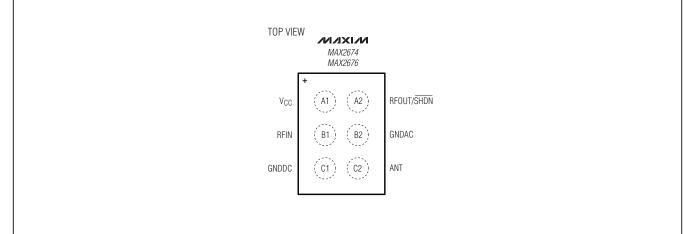
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Typical Operating Characteristics (continued)



MAX2674/MAX2676

Bump Configuration



Bump Description

PIN	NAME	FUNCTION
A1	Vcc	VCC. Place bypass capacitor as close as possible to the pin.
A2	RFOUT/ SHDN	RF Output and Shutdown Logic Input. Output match is included on-chip. Couple \overline{SHDN} logic control through a $25k\Omega$ resistor. DC logic-low shuts down the part.
B1	RFIN	RF Input. Requires a DC-blocking capacitor and an external inductor matching component.
B2	GNDAC	Ground for RF Circuits. Connect to the 2nd layer PCB ground plane with a via next to the pad.
C1	GNDDC	Ground for DC and Bias Circuits. Connect to the 2nd layer PCB ground plane with a via next to the pad.
C2	ANT	Antenna Input

Detailed Description

The MAX2674/MAX2676 are low-power LNAs designed for GPS/GNSS receiver applications. The devices feature low noise and high linearity in an ultra-small package. They also include an antenna switch and circuitry supporting bias to accommodate external LNA applications.

Input and Output Matching

To achieve optimal performance in noise figure, gain, and IIP3, the devices require one matching inductor at RFIN in series with a DC-blocking capacitor. RFOUT/SHDN is internally matched to 50Ω , eliminating the need for external matching components. At RFOUT/SHDN, an external DC-blocking capacitor should be used to isolate the shutdown control function.

Shutdown Mode

To place the device in shutdown mode, apply logic-low to RFOUT/SHDN through a $25k\Omega$ resistor. An additional DC-blocking capacitor or component is required at RFOUT/SHDN in this case. Apply a logic-high state or no DC bias to turn the part permanently on.

DC Supply Decoupling and Layout

A properly designed PC board (PCB) is essential to any RF microwave circuit. Use controlled-impedance lines on all high-frequency inputs and outputs. Bypass V_{CC} with a decoupling capacitor located close to the device.

For long V_C lines, it may be necessary to add additional decoupling capacitors. Locate these additional capacitors further away from the device package.

Proper grounding of GND_ pins is essential. If the PCB uses a top-side RF ground, connect it directly to the GND_ pins. For a board where the ground is not on the component layer, connect the GND_ pins to the board with multiple vias close to the package.

Antenna Switch Control

The MAX2674/MAX2676 ANT input includes an autodetection feature. When no current is drawn from ANT, the switch defaults to normal LNA operation. The pin can be directly connected to an external active antenna. The device automatically switches to the ANT input when an external active antenna is connected.

Refer to <u>www.maxim-ic.com</u> for the MAX2674/MAX2676 EV Kit schematic, layout files, BOM information, and S-parameters.

FREQUENCY (MHz)	NF _{MIN} (dB)	GAMMA_OPT MAG (°)	GAMMA_OPT PHASE (°)	Rn (Ω)
1550	0.651	0.446	44.1	8.33
1560	0.652	0.445	44.3	8.33
1570	0.654	0.445	44.6	8.32
1580	0.655	0.444	44.8	8.31
1590	0.656	0.444	45.1	8.3
1600	0.657	0.443	45.4	8.3

Table 1. MAX2674 Typical Noise Parameters ($V_{CC} = 2.85V$, $T_A = +25^{\circ}C$)

Table 2. MAX2676 Typical Noise Parameters ($V_{CC} = 2.85V$, $T_A = +25^{\circ}C$)

FREQUENCY (MHz)	NF _{MIN} (dB)	GAMMA_OPT MAG (°)	GAMMA_OPT PHASE (°)	Rn (Ω)
1550	0.744	0.441	53.1	8.7
1560	0.746	0.44	53.4	8.68
1570	0.748	0.439	53.7	8.66
1580	0.75	0.438	54	8.65
1590	0.751	0.437	54.3	8.63
1600	0.753	0.436	54.7	8.62

Chip Information

PROCESS: SiGe BiCMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE NO.	LAND
TYPE	CODE		PATTERN NO.
6 WLP	W61B1+1	<u>21-0217</u>	Refer to Application Note <u>1891</u>

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	12/10	Initial release	_

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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